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Embedded - System On Chip (SoC): The Heart of Modern Embedded Systems

Embedded - System On Chip (SoC) refers to an integrated circuit that consolidates all the essential components of a computer system into a single chip. This includes a microprocessor, memory, and other peripherals, all packed into one compact and efficient package. SoCs are designed to provide a complete computing solution, optimizing both space and power consumption, making them ideal for a wide range of embedded applications.

What are Embedded - System On Chip (SoC)?

System On Chip (SoC) integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions, SoCs combine a central

Details	
Product Status	Obsolete
Architecture	MCU, FPGA
Core Processor	Dual ARM® Cortex®-A9 MPCore™ with CoreSight™
Flash Size	-
RAM Size	64KB
Peripherals	DMA, POR, WDT
Connectivity	EBI/EMI, Ethernet, I²C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	800MHz
Primary Attributes	FPGA - 350K Logic Elements
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	1517-BBGA, FCBGA
Supplier Device Package	1517-FBGA, FC (40x40)
Purchase URL	https://www.e-xfl.com/product-detail/intel/5astfd3k3f40i5n

Feature	Description
Configuration	• Tamper protection-comprehensive design protection to protect your valuable IP investments • Enhanced advanced encryption standard (AES) design security features • CvP • Partial and dynamic reconfiguration of the FPGA • Active serial (AS) x1 and x4, passive serial (PS), JTAG, and fast passive parallel (FPP) x8, x16, and x32 (Arria V GZ) configuration options • Remote system upgrade

Arria V Device Variants and Packages

Table 3: Device Variants for the Arria V Device Family

Variant	Description
Arria V GX	FPGA with integrated 6.5536 Gbps transceivers that provides bandwidth, cost, and power levels that are optimized for high-volume data and signal-processing applications
Arria V GT	FPGA with integrated 10.3125 Gbps transceivers that provides enhanced high-speed serial I/O bandwidth for cost-sensitive data and signal processing applications
Arria V GZ	FPGA with integrated 12.5 Gbps transceivers that provides enhanced high-speed serial I/O bandwidth for high-performance and cost-sensitive data and signal processing applications
Arria V SX	SoC with integrated ARM-based HPS and 6.5536 Gbps transceivers
Arria V ST	SoC with integrated ARM-based HPS and 10.3125 Gbps transceivers

Arria V GX

This section provides the available options, maximum resource counts, and package plan for the Arria V GX devices.

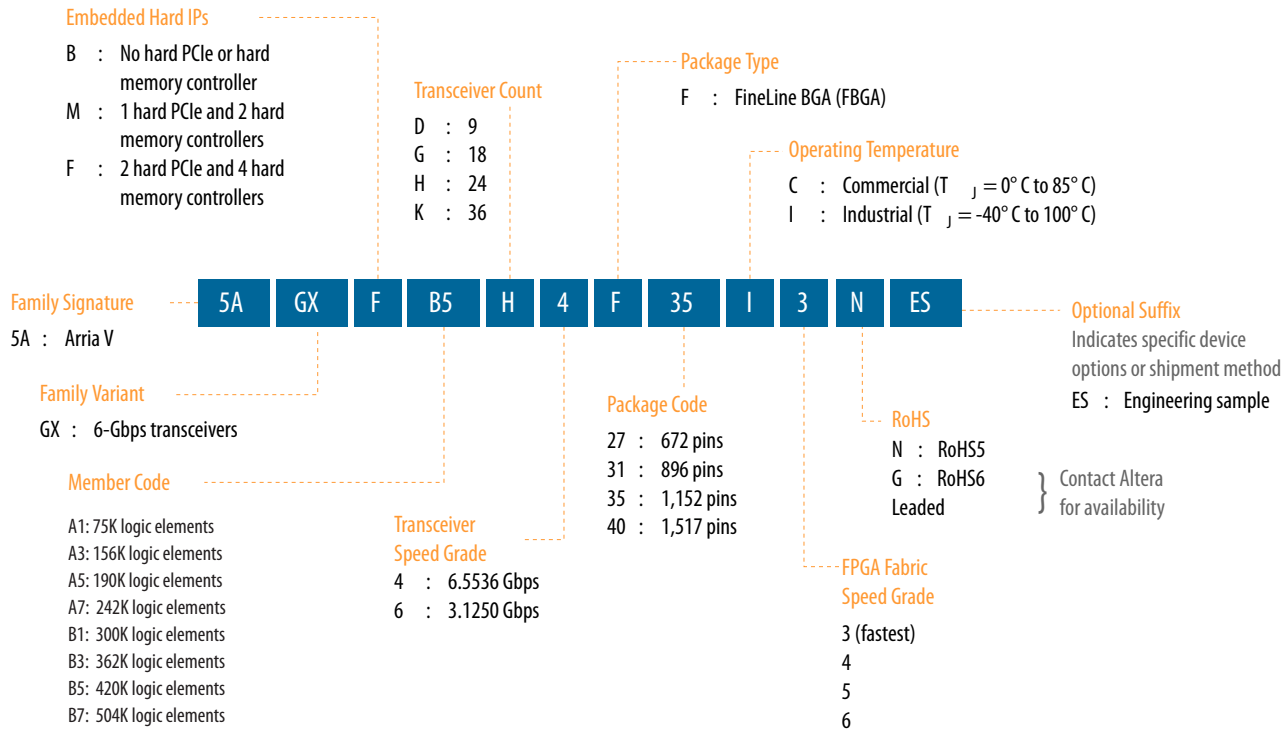
The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

Related Information

Altera Product Selector
Provides the latest information about Altera products.

Available Options

Figure 1: Sample Ordering Code and Available Options for Arria V GX Devices



Maximum Resources

Table 4: Maximum Resource Counts for Arria V GX Devices

Resource		Member Code							
		A1	A3	A5	A7	B1	B3	B5	B7
Logic Elements (LE) (K)		75	156	190	242	300	362	420	504
ALM		28,302	58,900	71,698	91,680	113,208	136,880	158,491	190,240
Register		113,208	235,600	286,792	366,720	452,832	547,520	633,964	760,960
Memory (Kb)	M10K	8,000	10,510	11,800	13,660	15,100	17,260	20,540	24,140
	MLAB	463	961	1,173	1,448	1,852	2,098	2,532	2,906
Variable-precision DSP Block		240	396	600	800	920	1,045	1,092	1,156
18 x 18 Multiplier		480	792	1,200	1,600	1,840	2,090	2,184	2,312
PLL		10	10	12	12	12	12	16	16

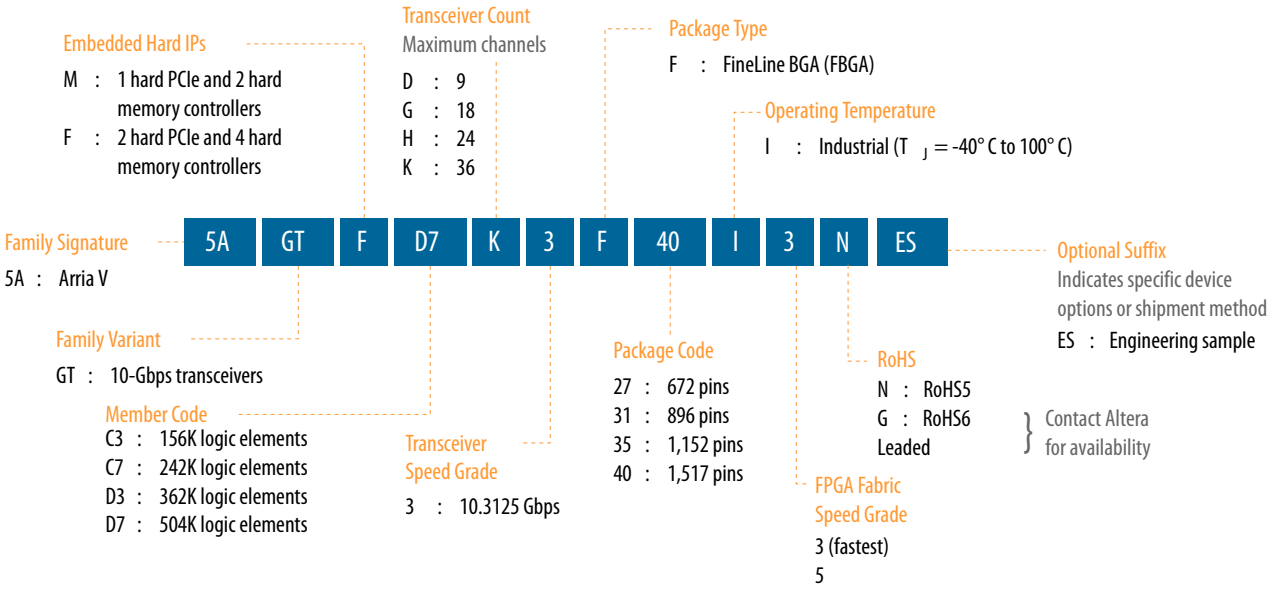
The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

Related Information

Altera Product Selector
Provides the latest information about Altera products.

Available Options

Figure 2: Sample Ordering Code and Available Options for Arria V GT Devices



Maximum Resources

Table 6: Maximum Resource Counts for Arria V GT Devices

Resource		Member Code			
		C3	C7	D3	D7
Logic Elements (LE) (K)		156	242	362	504
ALM		58,900	91,680	136,880	190,240
Register		235,600	366,720	547,520	760,960
Memory (Kb)	M10K	10,510	13,660	17,260	24,140
	MLAB	961	1,448	2,098	2,906
Variable-precision DSP Block		396	800	1,045	1,156
18 x 18 Multiplier		792	1,600	2,090	2,312
PLL		10	12	12	16

Resource		Member Code			
		C3	C7	D3	D7
Transceiver	6 Gbps(4)	3 (9)	6 (24)	6 (24)	6 (36)
	10 Gbps(5)	4	12	12	20
GPIO(6)		416	544	704	704
LVDS	Transmitter	68	120	160	160
	Receiver	80	136	176	176
PCIe Hard IP Block		1	2	2	2
Hard Memory Controller		2	4	4	4

Related Information

- **High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook**
  Provides the number of LVDS channels in each device package.
- **Transceiver Architecture in Arria V Devices**
  Describes 10 Gbps channels usage conditions and SFF-8431 compliance requirements.

Package Plan

Table 7: Package Plan for Arria V GT Devices

Member Code	F672 (27 mm)			F896 (31 mm)			F1152 (35 mm)			F1517 (40 mm)		
	GPIO	XCVR		GPIO	XCVR		GPIO	XCVR		GPIO	XCVR	
		6-Gbps	10-Gbps		6-Gbps	10-Gbps		6-Gbps	10-Gbps		6-Gbps	10-Gbps
C3	336	3 (9)	4	416	3 (9)	4	—	—	—	—	—	—
C7	—	—	—	384	6 (18)	8	544	6 (24)	12	—	—	—
D3	—	—	—	384	6 (18)	8	544	6 (24)	12	704	6 (24)	12
D7	—	—	—	—	—	—	544	6 (24)	12	704	6 (36)	20

The 6-Gbps transceiver counts are for dedicated 6-Gbps channels. You can also configure any pair of 10-Gbps channels as three 6-Gbps channels—the total number of 6-Gbps channels are shown in brackets. For example, you can also configure the Arria V GT D7 device in the F1517 package with nine 6-Gbps

(4) The 6 Gbps transceiver counts are for dedicated 6-Gbps channels. You can also configure any pair of 10 Gbps channels as three 6 Gbps channels-the total number of 6 Gbps channels are shown in brackets.
(5) Chip-to-chip connections only. For 10 Gbps channel usage conditions, refer to the Transceiver Architecture in Arria V Devices chapter.
(6) The number of GPIOs does not include transceiver I/Os. In the Quartus Prime software, the number of user I/Os includes transceiver I/Os.

Resource		Member Code			
		E1	E3	E5	E7
Memory (Kb)	M20K	11,700	19,140	28,800	34,000
	MLAB	2,594	4,245	4,718	5,306
Variable-precision DSP Block		800	1,044	1,092	1,139
18 x 18 Multiplier		1,600	2,088	2,184	2,278
PLL		20	20	24	24
12.5 Gbps Transceiver		24	24	36	36
GPIO[7]		414	414	674	674
LVDS	Transmitter	99	99	166	166
	Receiver	108	108	168	168
PCIe Hard IP Block		1	1	1	1

Related Information

High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook
Provides the number of LVDS channels in each device package.

Package Plan

Table 9: Package Plan for Arria V GZ Devices

Member Code	H780 (33 mm)		F1152 (35 mm)		F1517 (40 mm)	
	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR
E1	342	12	414	24	—	—
E3	342	12	414	24	—	—
E5	—	—	534	24	674	36
E7	—	—	534	24	674	36

Arria V SX

This section provides the available options, maximum resource counts, and package plan for the Arria V SX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

(7) The number of GPIOs does not include transceiver I/Os. In the Quartus Prime software, the number of user I/Os includes transceiver I/Os.

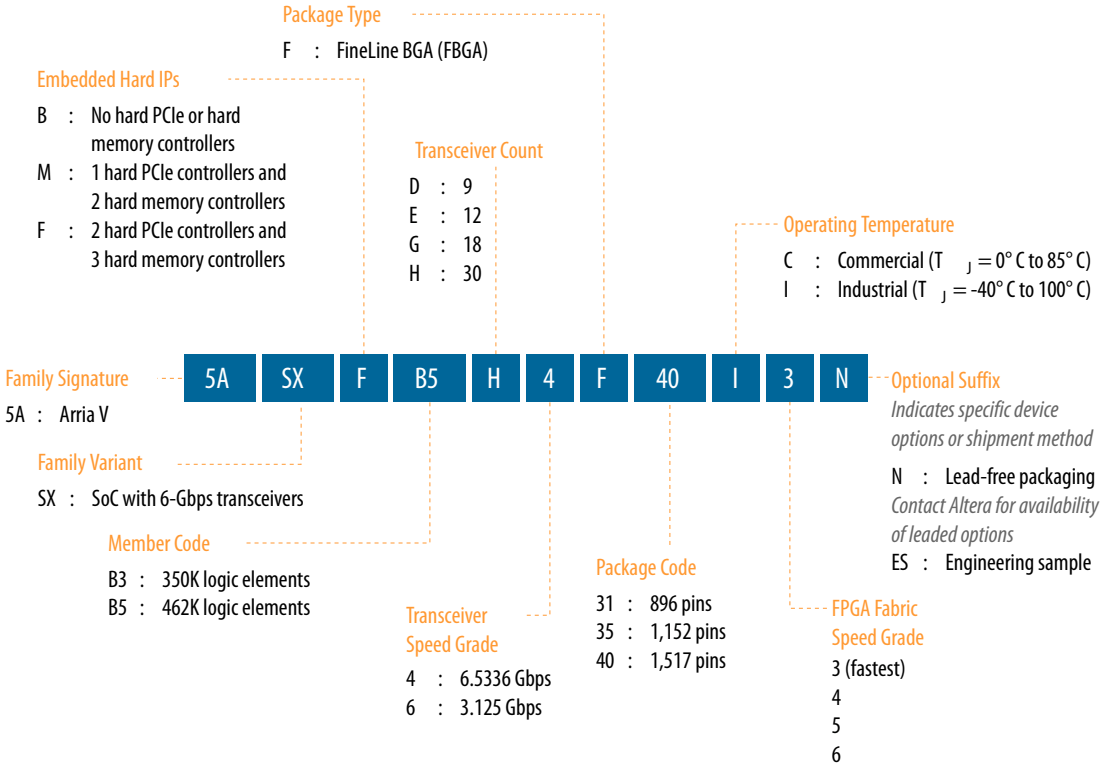
Related Information

Altera Product Selector
Provides the latest information about Altera products.

Available Options

Figure 4: Sample Ordering Code and Available Options for Arria V SX Devices

The –3 FPGA fabric speed grade is available only for industrial temperature devices.



Maximum Resources

Table 10: Maximum Resource Counts for Arria V SX Devices

Resource		Member Code	
		B3	B5
Logic Elements (LE) (K)		350	462
ALM		132,075	174,340
Register		528,300	697,360
Memory (Kb)	M10K	17,290	22,820
	MLAB	2,014	2,658
Variable-precision DSP Block		809	1,090
18 x 18 Multiplier		1,618	2,180

Resource		Member Code	
		B3	B5
FPGA PLL		14	14
HPS PLL		3	3
6 Gbps Transceiver		30	30
FPGA GPIO[8]		540	540
HPS I/O		208	208
LVDS	Transmitter	120	120
	Receiver	136	136
PCIe Hard IP Block		2	2
FPGA Hard Memory Controller		3	3
HPS Hard Memory Controller		1	1
ARM Cortex-A9 MPCore Processor		Dual-core	Dual-core

Related Information

High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook

Provides the number of LVDS channels in each device package.

Package Plan

Table 11: Package Plan for Arria V SX Devices

The HPS I/O counts are the number of I/Os in the HPS and does not correlate with the number of HPS-specific I/O pins in the FPGA. Each HPS-specific pin in the FPGA may be mapped to several HPS I/Os.

Member Code	F896 (31 mm)			F1152 (35 mm)			F1517 (40 mm)		
	FPGA GPIO	HPS I/O	XCVR	FPGA GPIO	HPS I/O	XCVR	FPGA GPIO	HPS I/O	XCVR
B3	250	208	12	385	208	18	540	208	30
B5	250	208	12	385	208	18	540	208	30

Arria V ST

This section provides the available options, maximum resource counts, and package plan for the Arria V ST devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

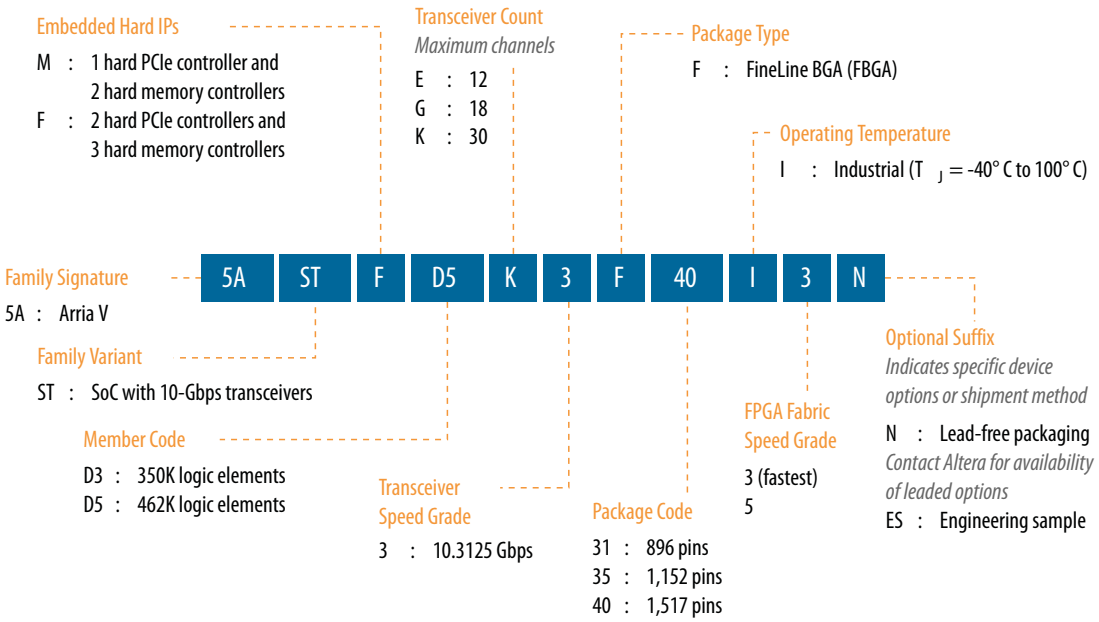
[8] The number of GPIOs does not include transceiver I/Os. In the Quartus Prime software, the number of user I/Os includes transceiver I/Os.

Related Information

Altera Product Selector
Provides the latest information about Altera products.

Available Options

Figure 5: Sample Ordering Code and Available Options for Arria V ST Devices



Maximum Resources

Table 12: Maximum Resource Counts for Arria V ST Devices

Resource		Member Code	
		D3	D5
Logic Elements (LE) (K)		350	462
ALM		132,075	174,340
Register		528,300	697,360
Memory (Kb)	M10K	17,290	22,820
	MLAB	2,014	2,658
Variable-precision DSP Block		809	1,090
18 x 18 Multiplier		1,618	2,180
FPGA PLL		14	14
HPS PLL		3	3
Transceiver	6-Gbps	30	30
	10-Gbps[9]	16	16

Related Information

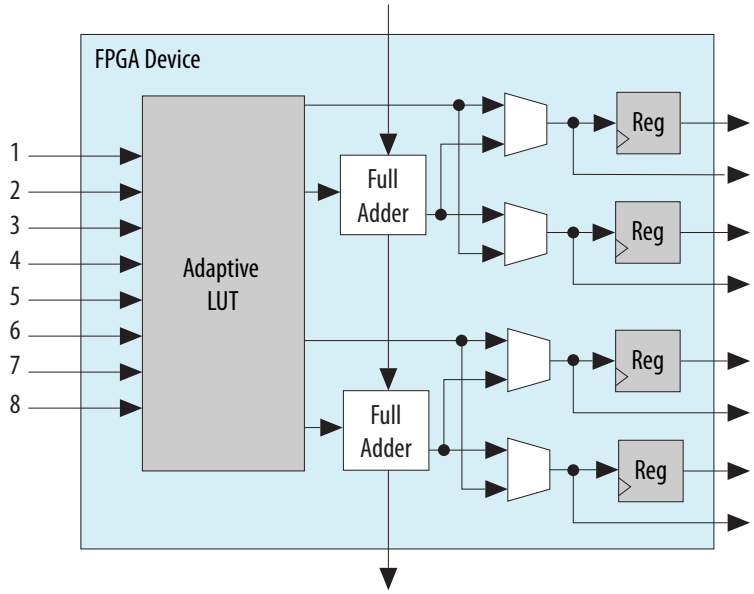
- **Managing Device I/O Pins chapter, Quartus Prime Handbook**
  Provides more information about vertical I/O migrations.
- **Power Management in Arria V Devices**
  Describes the power-up sequence required for Arria V GX and GT devices.

Adaptive Logic Module

Arria V devices use a 28 nm ALM as the basic building block of the logic fabric.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than previous generations.

Figure 7: ALM for Arria V Devices



You can configure up to 50% of the ALMs in the Arria V devices as distributed memory using MLABs.

Related Information

Embedded Memory Capacity in Arria V Devices on page 20
Lists the embedded memory capacity for each device.

Variable-Precision DSP Block

Arria V devices feature a variable-precision DSP block that supports these features:

- Configurable to support signal processing precisions ranging from 9 x 9, 18 x 18, 27 x 27, and 36 x 36 bits natively
- A 64-bit accumulator
- Double accumulator
- A hard preadder that is available in both 18- and 27-bit modes
- Cascaded output adders for efficient systolic finite impulse response (FIR) filters
- Dynamic coefficients
- 18-bit internal coefficient register banks
- Enhanced independent multiplier operation
- Efficient support for single-precision floating point arithmetic
- The inferability of all modes by the Quartus Prime design software

Table 14: Variable-Precision DSP Block Configurations for Arria V Devices

Usage Example	Multiplier Size (Bit)	DSP Block Resource
Low precision fixed point for video applications	Three 9 x 9	1
Medium precision fixed point in FIR filters	Two 18 x 18	1
FIR filters	Two 18 x 18 with accumulate	1
Single-precision floating-point implementations	One 27 x 27	1
Very high precision fixed point implementations	One 36 x 36	2

You can configure each DSP block during compilation as independent three 9 x 9, two 18 x 18, or one 27 x 27 multipliers. Using two DSP block resources, you can also configure a 36 x 36 multiplier for high-precision applications. With a dedicated 64 bit cascade bus, you can cascade multiple variable-precision DSP blocks to implement even higher precision DSP functions efficiently.

Related Information

External Memory Interface Spec Estimator
For the latest information and to estimate the external memory system performance specification, use Altera's External Memory Interface Spec Estimator tool.

Low-Power Serial Transceivers

Arria V devices deliver the industry's lowest power consumption per transceiver channel:

- 12.5 Gbps transceivers at less than 170 mW
- 10 Gbps transceivers at less than 165 mW
- 6 Gbps transceivers at less than 105 mW

Arria V transceivers are designed to be compliant with a wide range of protocols and data rates.

Transceiver Channels

The transceivers are positioned on the left and right outer edges of the device. The transceiver channels consist of the physical medium attachment (PMA), physical coding sublayer (PCS), and clock networks.

The following figures are graphical representations of a top view of the silicon die, which corresponds to a reverse view for flip chip packages. Different Arria V devices may have different floorplans than the ones shown in the figures.

Figure 9: Device Chip Overview for Arria V GX and GT Devices

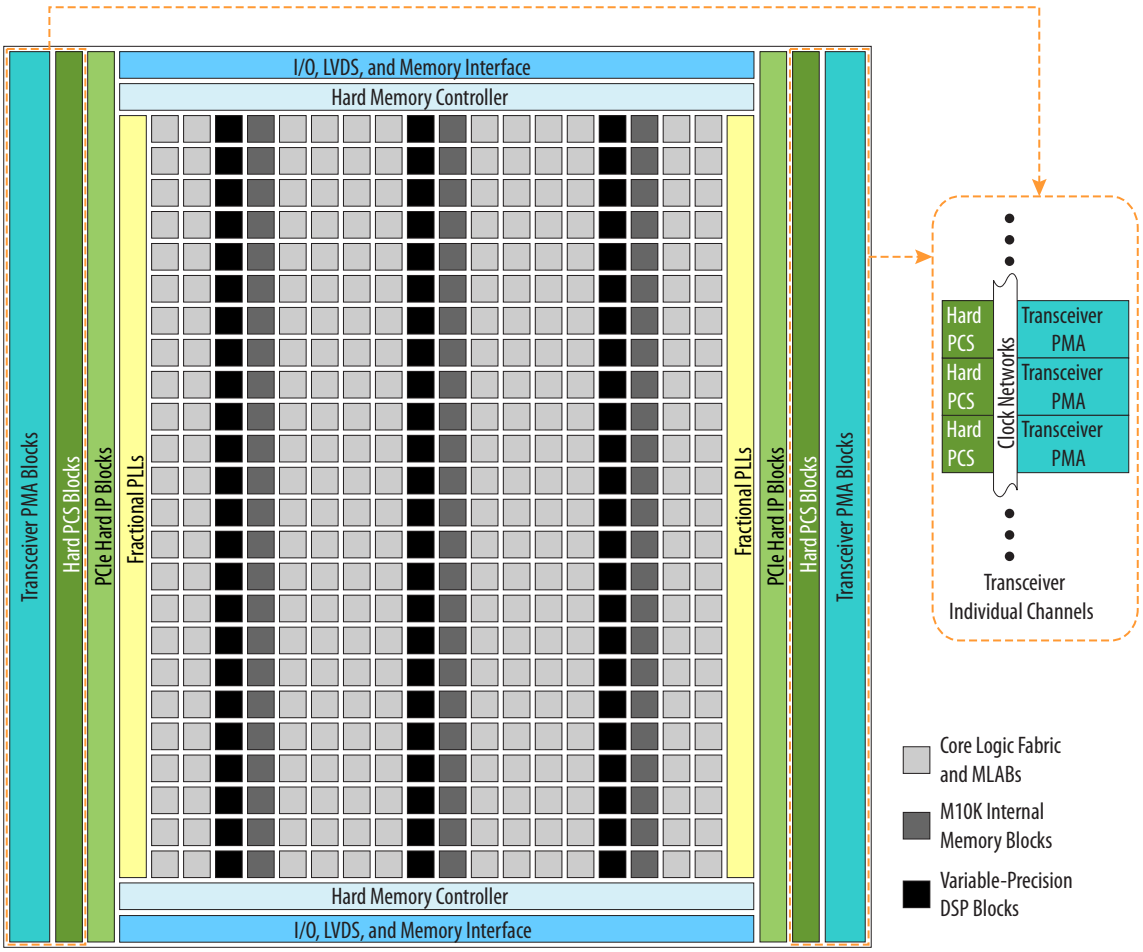
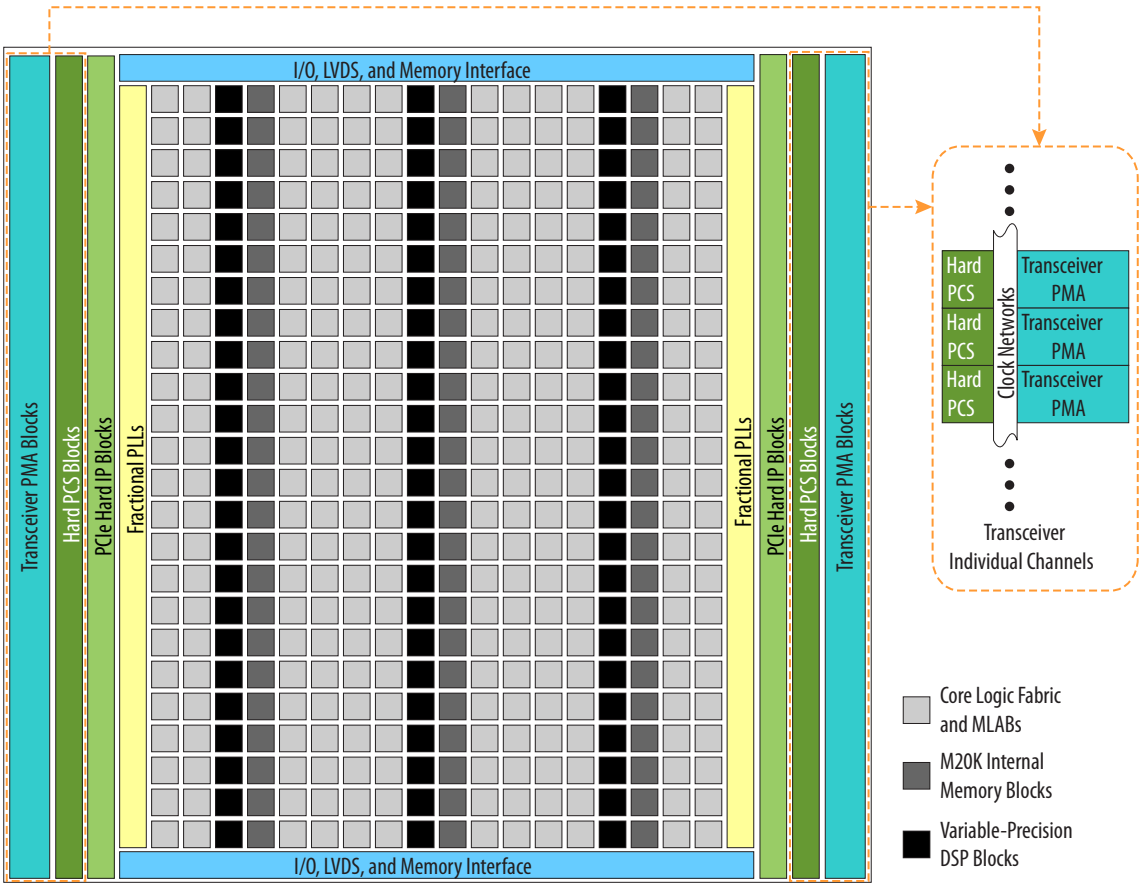


Figure 10: Device Chip Overview for Arria V GZ Devices



Features	Capability
PLL-based clock recovery	Superior jitter tolerance
Programmable serializer and deserializer (SERDES)	Flexible SERDES width
Equalization and pre-emphasis	• Arria V GX, GT, SX, and ST devices—Up to 14.37 dB of pre-emphasis and up to 4.7 dB of equalization • Arria V GZ devices—4-tap pre-emphasis and de-emphasis
Ring oscillator transmit PLLs	611 Mbps to 10.3125 Gbps
LC oscillator ATX transmit PLLs (Arria V GZ devices only)	600 Mbps to 12.5 Gbps
Input reference clock range	27 MHz to 710 MHz
Transceiver dynamic reconfiguration	Allows the reconfiguration of a single channel without affecting the operation of other channels

PCS Features

The Arria V core logic connects to the PCS through an 8, 10, 16, 20, 32, 40, 64, 66, or 67 bit interface, depending on the transceiver data rate and protocol. Arria V devices contain PCS hard IP to support PCIe Gen1, Gen2, and Gen3, GbE, Serial RapidIO (SRIO), GPON, and CPRI.

All other standard and proprietary protocols within the following speed ranges are also supported:

- 611 Mbps to 6.5536 Gbps—supported through the custom double-width mode (up to 6.5536 Gbps) and custom single-width mode (up to 3.75 Gbps) of the transceiver PCS hard IP.
- 6.5536 Gbps to 10.3125 Gbps—supported through dedicated 80 or 64 bit interface that bypass the PCS hard IP and connects the PMA directly to the core logic. In Arria V GZ, this is supported in the transceiver PCS hard IP.

Table 21: Transceiver PCS Features for Arria V GX, GT, ST, and SX Devices

PCS Support[13]	Data Rates (Gbps)	Transmitter Data Path Feature	Receiver Data Path Feature
Custom single- and double-width modes	0.611 to ~6.5536	• Phase compensation FIFO • Byte serializer • 8B/10B encoder	• Word aligner • 8B/10B decoder • Byte deserializer • Phase compensation FIFO
SRIO	1.25 to 6.25		
Serial ATA	1.5, 3.0, 6.0		

[13] Data rates above 6.5536 Gbps up to 10.3125 Gbps, such as 10GBASE-R, are supported through the soft PCS.

Protocol	Data Rates (Gbps)	Transmitter Data Path Features	Receiver Data Path Features
40GBASE-R Ethernet	4 x 10.3125	• TX FIFO • 64B/66B encoder • Scrambler • Alignment marker insertion • Gearbox • Block stripper	• RX FIFO • 64B/66B decoder • Descrambler • Lane reorder • Deskew • Alignment marker lock • Block synchronization • Gear box • Destripper
100GBASE-R Ethernet	10 x 10.3125		
40G and 100G OTN	(4 +1) x 11.3 (10 +1) x 11.3	• TX FIFO • Channel bonding • Byte serializer	• RX FIFO • Lane deskew • Byte deserializer
GbE	1.25	• Phase compensation FIFO • Byte serializer • 8B/10B encoder • Bit-slip • Channel bonding • GbE state machine	• Word aligner • Deskew FIFO • Rate match FIFO • 8B/10B decoder • Byte deserializer • Byte ordering • GbE state machine
XAUI	3.125 to 4.25	• Phase compensation FIFO • Byte serializer • 8B/10B encoder • Bit-slip • Channel bonding • XAUI state machine for bonding four channels	• Word aligner • Deskew FIFO • Rate match FIFO • 8B/10B decoder • Byte deserializer • Byte ordering • XAUI state machine for realigning four channels
SRIO	1.25 to 6.25	• Phase compensation FIFO • Byte serializer • 8B/10B encoder • Bit-slip • Channel bonding • SRIO V2.1-compliant x2 and x4 channel bonding	• Word aligner • Deskew FIFO • Rate match FIFO • 8B/10B decoder • Byte deserializer • Byte ordering • SRIO V2.1-compliant x2 and x4 deskew state machine

SoC with HPS

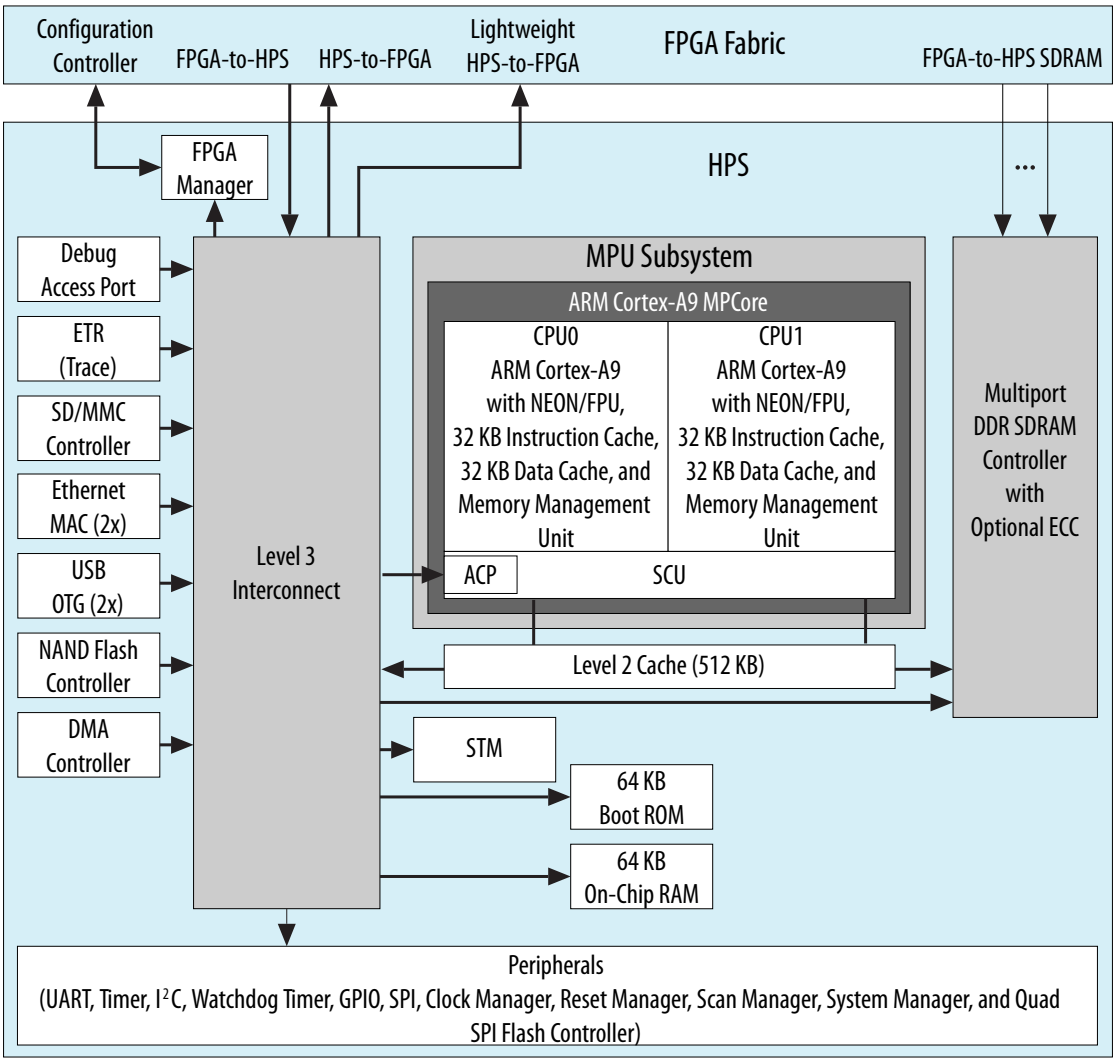
Each SoC combines an FPGA fabric and an HPS in a single device. This combination delivers the flexibility of programmable logic with the power and cost savings of hard IP in these ways:

- Reduces board space, system power, and bill of materials cost by eliminating a discrete embedded processor
- Allows you to differentiate the end product in both hardware and software, and to support virtually any interface standard
- Extends the product life and revenue through in-field hardware and software updates

HPS Features

The HPS consists of a dual-core ARM Cortex-A9 MPCore processor, a rich set of peripherals, and a shared multiport SDRAM memory controller, as shown in the following figure.

Figure 12: HPS with Dual-Core ARM Cortex-A9 MPCore Processor



System Peripherals and Debug Access Port

Each Ethernet MAC, USB OTG, NAND flash controller, and SD/MMC controller module has an integrated DMA controller. For modules without an integrated DMA controller, an additional DMA controller module provides up to eight channels of high-bandwidth data transfers. Peripherals that communicate off-chip are multiplexed with other peripherals at the HPS pin level. This allows you to choose which peripherals to interface with other devices on your PCB.

The debug access port provides interfaces to industry standard JTAG debug probes and supports ARM CoreSight debug and core traces to facilitate software development.

HPS–FPGA AXI Bridges

The HPS–FPGA bridges, which support the Advanced Microcontroller Bus Architecture (AMBA®) Advanced eXtensible Interface (AXI™) specifications, consist of the following bridges:

- FPGA-to-HPS AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the FPGA fabric to issue transactions to slaves in the HPS.
- HPS-to-FPGA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the HPS to issue transactions to slaves in the FPGA fabric.
- Lightweight HPS-to-FPGA AXI bridge—a lower latency 32 bit width bus that allows the HPS to issue transactions to slaves in the FPGA fabric. This bridge is primarily used for control and status register (CSR) accesses to peripherals in the FPGA fabric.

The HPS–FPGA AXI bridges allow masters in the FPGA fabric to communicate with slaves in the HPS logic, and vice versa. For example, the HPS-to-FPGA AXI bridge allows you to share memories instantiated in the FPGA fabric with one or both microprocessors in the HPS, while the FPGA-to-HPS AXI bridge allows logic in the FPGA fabric to access the memory and peripherals in the HPS.

Each HPS–FPGA bridge also provides asynchronous clock crossing for data transferred between the FPGA fabric and the HPS.

HPS SDRAM Controller Subsystem

The HPS SDRAM controller subsystem contains a multiport SDRAM controller and DDR PHY that are shared between the FPGA fabric (through the FPGA-to-HPS SDRAM interface), the level 2 (L2) cache, and the level 3 (L3) system interconnect. The FPGA-to-HPS SDRAM interface supports AMBA AXI and Avalon® Memory-Mapped (Avalon-MM) interface standards, and provides up to six individual ports for access by masters implemented in the FPGA fabric.

To maximize memory performance, the SDRAM controller subsystem supports command and data reordering, deficit round-robin arbitration with aging, and high-priority bypass features. The SDRAM controller subsystem supports DDR2, DDR3, or LPDDR2 devices up to 4 Gb in density operating at up to 533 MHz (1066 Mbps data rate).

FPGA Configuration and Processor Booting

The FPGA fabric and HPS in the SoC are powered independently. You can reduce the clock frequencies or gate the clocks to reduce dynamic power, or shut down the entire FPGA fabric to reduce total system power.

Mode	Data Width	Max Clock Rate (MHz)	Max Data Rate (Mbps)	Decompressio	Design Security	Partial Reconfiguratio (20)	Remote System Update
FPP	8 bits	125	—	Yes	Yes	—	Parallel flash loader
	16 bits	125	—	Yes	Yes	Yes(21)	
	32 bits(22)	100	—	Yes	Yes	—	
CvP (PCIe)	x1, x2, x4, and x8 lanes	—	—	Yes	Yes	Yes	—
JTAG	1 bit	33	33	—	—	—	—
Configuration via HPS	16 bits	125	—	Yes	Yes	Yes (21)	Parallel flash loader
	32 bits	100	—	Yes	Yes	—	

Instead of using an external flash or ROM, you can configure the Arria V devices through PCIe using CvP. The CvP mode offers the fastest configuration rate and flexibility with the easy-to-use PCIe hard IP block interface. The Arria V CvP implementation conforms to the PCIe 100 ms power-up-to-active time requirement.

Note: Although Arria V GZ devices support PCIe Gen3, you can use only PCIe Gen1 and PCIe Gen2 for CvP configuration scheme.

Related Information

Configuration via Protocol (CvP) Implementation in Altera FPGAs User Guide
Provides more information about CvP.

Power Management

Leveraging the FPGA architectural features, process technology advancements, and transceivers that are designed for power efficiency, the Arria V devices consume less power than previous generation Arria V FPGAs:

- Total device core power consumption—less by up to 50%.
- Transceiver channel power consumption—less by up to 50%.

Additionally, Arria V devices contain several hard IP blocks, including PCIe Gen1, Gen2, and Gen3, GbE, SRIO, GPON, and CPRI protocols, that reduce logic resources and deliver substantial power savings of up to 25% less power than equivalent soft implementations.

(20) Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Altera for support.
(21) Supported at a maximum clock rate of 62.5 MHz.
(22) Arria V GZ only

Document Revision History

Date	Version	Changes
December 2015	2015.12.21	• Updated RoHS and optional suffix information in sample ordering code and available options diagrams for Arria V GX and GT devices. • Changed instances of *Quartus II* to *Quartus Prime*.
January 2015	2015.01.23	• Updated package dimension for Arria V GZ H780 package from 29 mm to 33 mm. • Updated dual-core ARM Cortex-A9 MPCore processor maximum frequency from 800 MHz to 1.05 GHz.
December 2013	2013.12.26	• 10-Gbps Ethernet (10GbE) PCS and Interlaken PCS are for Arria V GZ only. • Removed "Preliminary" texts from Ordering Code figures, Maximum Resources, Package Plan and I/O Vertical Migration tables. • Added link to **Altera Product Selector** for each device variant. • Added leaded package options. • Removed the note "The number of PLLs includes general-purpose fractional PLLs and transceiver fractional PLLs." for all PLLs in the Maximum Resource Counts table. • Corrected FPGA GPIO for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 F896 package from 170 to 250. • Corrected FPGA GPIO for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 F1152 package from 350 to 385. • Corrected FPGA GPIO for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 F1517 package from 528 to 540. • Corrected LVDS Transmitter for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 devices from 121 to 120. • Added links to Altera's **External Memory Spec Estimator** tool to the topics listing the external memory interface performance. • Added x2 for PCIe Gen3, Gen 2, and Gen 1.
August 2013	2013.08.19	• Removed the note about the PCIe hard IP on the right side of the device in the F896 package of the Arria V GX variant. These devices do not have PCIe hard IP on the right side. • Added transceiver speed grade 6 to the available options of the Arria V SX variant. • Corrected the maximum LVDS transmitter channel counts for the Arria V GX A1 and A3 devices from 68 to 67. • Corrected the maximum FPGA GPIO count for Arria V ST D5 devices from 540 to 528.

Date	Version	Changes
June 2013	2013.06.03	• Removed statements about contacting Altera for SFF-8431 compliance requirements. Refer to the **Transceiver Architecture in Arria V Devices** chapter for the requirements.
May 2013	2013.05.06	• Moved all links to the Related Information section of respective topics for easy reference. • Added link to the known document issues in the Knowledge Base. • Updated the available options, maximum resource counts, and per package information for the Arria V SX and ST device variants. • Updated the variable DSP multipliers counts for the Arria V SX and ST device variants. • Clarified that partial reconfiguration is an advanced feature. Contact Altera for support of the feature. • Added footnote to clarify that MLAB 64 bits depth is available only for Arria V GZ devices. • Updated description about power-up sequence requirement for device migration to improve clarity.
January 2013	2013.01.11	• Added the L optional suffix to the Arria V GZ ordering code for the –I3 speed grade. • Added a note about the power-up sequence requirement if you plan to migrate your design from the Arria V GX A5 and A7, and Arria V GT C7 devices to other Arria V devices.
November 2012	2012.11.19	• Updated the summary of features. • Updated Arria V GZ information regarding 3.3 V I/O support. • Removed Arria V GZ engineering sample ordering code. • Updated the maximum resource counts for Arria V GX and GZ. • Updated Arria V ST ordering codes for transceiver count. • Updated transceiver counts for Arria V ST packages. • Added simplified floorplan diagrams for Arria V GZ, SX, and ST. • Added FPP x32 configuration mode for Arria V GZ only. • Updated CvP (PCIe) remote system update support information. • Added HPS external memory performance information. • Updated template.
October 2012	3.0	• Added Arria V GZ information. • Updated Table 1, Table 2, Table 3, Table 14, Table 15, Table 16, Table 17, Table 18, Table 19, Table 20, and Table 21. • Added the “Arria V GZ” section. • Added Table 8, Table 9 and Table 22.